

Data Sheet

Palcusil[®] 25

Description:

High-purity silver, copper and palladium alloy for vacuum brazing.
Nominal composition by weight: **54% Ag, 21% Cu and 25% Pd**

Prime features:

- Similar to Nioro, lower cost and density
- Excellent for vacuum-tight joints

Suggested base materials:

- Kovar, Copper, Nickel, Carbon/low alloy & Tool/high speed steel, Stainless steel, Ni-based super alloys, Metallized Ceramic, Tungsten carbide

Typical applications:

- RF windows
- Feedthurs

Physical Properties*

Liquidus Temperature	950 °C
	1742 °F
Solidus Temperature	900 °C
	1652 °F
Coefficient of Thermal Expansion (CTE)	
Thermal Conductivity (Calculated)	
Density	
Yield Strength (0.2% offset)	
Tensile Strength	
Elongation (2in/50mm gage section)	
Electrical Resistivity	
Electrical Conductivity	
Vapor Pressure (Calculated)	
Recommended Brazing Temperatures	
Recommended Brazing Atmospheres	10 ⁻⁵ mm Hg, H ₂ , or inert gas

* Please note that all values quoted are based on test pieces and may vary according to component design. These values are not guaranteed in any way and should only be treated as indicative values. They should be used for guidance only and for no other purpose whatsoever.

Impurity Limits

Zn	less than 0.001%
Cd	less than 0.001%
Pb	less than 0.002%
P	less than 0.002%
C	less than 0.01%

All other metallic impurities having a vapor pressure higher than 10⁻⁷ mm Hg at 500 °C are limited to 0.002% each. Impurities having a vapor pressure lower than 10⁻⁷ mm Hg at 500 °C are limited to a total of 0.075%. (This applies to all forms except powder and extrudable paste.)

Supplied as:

- Foil
- Flexibraze
- Wire
- Powder
- Extrudable paste
- Preforms

The determination as to the adaptability of any Wesgo materials to the specific needs of the Buyer is solely the Buyer's prerogative and responsibility. All technical information, data and recommendations are based on tests and accumulated experience data, which Wesgo believed to be reliable. However, the accuracy and completeness thereof are not guaranteed.